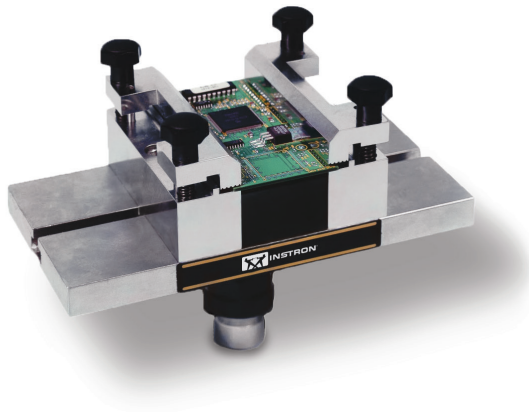
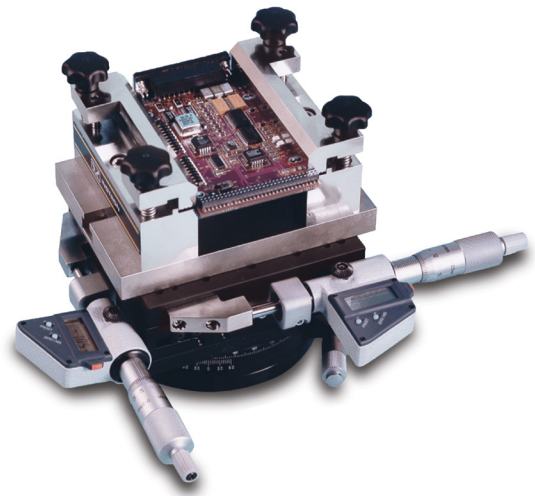


## 2860 SERIES PCB CLAMPING STAGE

2860-200



2860-200 PCB clamp



PCB clamp on X-Y stage

The clamping stage may be mounted directly to the base of a testing machine or it can be fitted to an X-Y translation stage (e.g. Instron® 2860-101) in order to provide accurate adjustment and indexing of the specimen position during testing.

### APPLICATION

The PCB clamping stage provides a rigid clamping base for the testing of microelectronic circuit boards and components. In a typical test configuration the assembly under test would be mounted in the 2860-200 PCB clamping stage fitted to an X-Y translation stage (e.g. Instron 2860-101) or directly to the base of a test machine and a lead pull grip would be mounted below the load cell on the moving crosshead or actuator.

### FEATURES

- Capacity: 500 N (100 lb, 50 kgf)
- Clamping span: Adjustable 0 to 150 mm (0 to 6 in)
- Variable specimen thickness
- Fitting: Type Om (12 mm connection with 6 mm clevis pin), may also be mounted on 2860-101 Theta-X-Y manual translation stage.

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